

Data Sheet

HDSP-52xE Series, HDSP-52xG Series, HDSP-52xY Series

14.2-mm (0.56-inch) General-Purpose Two-Digit Seven-Segment Displays



Description

These Broadcom[®] 14.2-mm (0.56-inch) two-digit displays use industry-standard size and pinout. The devices are available as either common anode or common cathode. These grayfaced displays are available in a choice of AllnGaP Red, AllnGaP Green, or AllnGaP Yellow colors. The HDSP-521x and HDSP-523x are suitable for indoor use.

Applications

- Suitable for indoor use
- Not recommended for industrial applications
- Extreme temperature cycling not recommended
- **NOTE:** For additional details, contact your local Broadcom sales office or an authorized distributor.

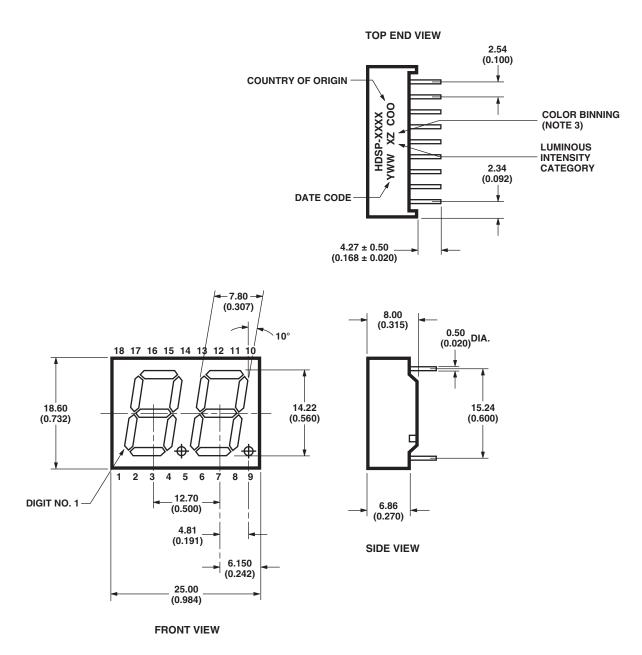
Features

- Industry-standard size
- Industry-standard pinout 15.24-mm (0.6-in.) DIP leads on 2.54-mm (0.1-in.) centers
- Choice of colors
 - AllnGaP Red, AllnGaP Green, and AllnGaP Yellow
- Excellent appearance
 - Mitered font
 - Mitered corners on segments
 - Gray face paint
 - Gray package gives optimum contrast
 - ±50° viewing angle
- Design flexibility
 - Common anode or common cathode
- Categorized for luminous intensity
 - Green and yellow categorized for color

Devices

AllnGaP Red	AllnGaP Green	AllnGaP Yellow	Description
HDSP-521E	HDSP-521G	HDSP-521Y	Common Anode Right Hand Decimal
HDSP-523E	HDSP-523G	HDSP-523Y	Common Cathode Right Hand Decimal

Package Dimensions

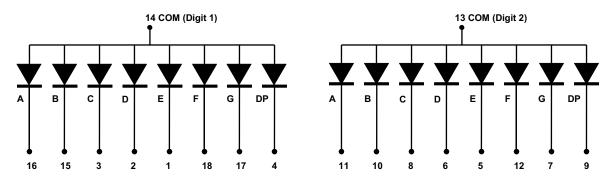


NOTE:

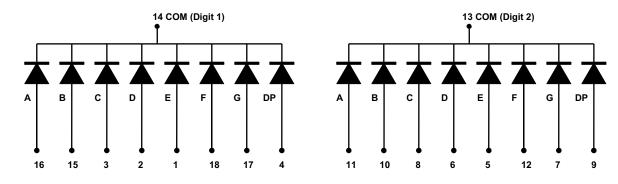
- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is 0.25 mm (0.01 in.) unless otherwise stated.
- 3. For green and yellow only.

Internal Circuit Diagram

Common Anode



Common Cathode



	COMMON ANODE		COMMON CATHODE	
PIN	FUNCTION	PIN	FUNCTION	
1	E CATHODE NO. 1	1	E ANODE NO. 1	
2	D CATHODE NO. 1	2	D ANODE NO. 1	
3	C CATHODE NO. 1	3	C ANODE NO. 1	
4	DP CATHODE NO. 1	4	DP ANODE NO. 1	
5	E CATHODE NO. 2	5	E ANODE NO. 2	
6	D CATHODE NO. 2	6	D ANODE NO. 2	
7	G CATHODE NO. 2	7	G ANODE NO. 2	
8	C CATHODE NO. 2	8	C ANODE NO. 2	
9	DP CATHODE NO. 2	9	DP ANODE NO. 2	
10	B CATHODE NO. 2	10	B ANODE NO. 2	
11	A CATHODE NO. 2	11	A ANODE NO. 2	
12	F CATHODE NO. 2	12	F ANODE NO. 2	
13	DIGIT NO. 2 ANODE	13	DIGIT NO. 2 CATHODE	
14	DIGIT NO. 1 ANODE	14	DIGIT NO. 1 CATHODE	
15	B CATHODE NO. 1	15	B ANODE NO. 1	
16	A CATHODE NO. 1	16	A ANODE NO. 1	
17	G CATHODE NO. 1	17	G ANODE NO. 1	
18	F CATHODE NO. 1	18	F ANODE NO. 1	

Absolute Maximum Ratings at $T_A = 25^{\circ}C$

Parameter	Red HDSP-521E HDSP-523E	Green HDSP-521G HDSP-523G	Yellow HDSP-521Y HDSP-523Y	Unit
Power Dissipation per Segment or DP	62.5	62.5	50	mW
Peak Forward Current per Segment or DP ^a	90	90	60	mA
DC Forward Current per Segment or DP	25 ^b	25 ^c	20 ^d	mA
Operating Temperature Range	-40 to +85	-40 to +85	-40 to +85	°C
Storage Temperature Range	-40 to +85	-40 to +85	-40 to +85	°C
Reverse Voltage per Segment or DP ^e	5	5	5	V
Wave Soldering Temperature for 3 Seconds (at 2-mm distance from the body)	250	250	250	°C

a. Duty factor = 10%, frequency = 1 kHz, $T_A = 25^{\circ}C$.

- b. Derate linearly as shown in Figure 4.
- c. Derate linearly as shown in Figure 8.
- d. Derate linearly as shown in Figure 12.
- e. Reverse Voltage is for LED testing purposes and is not recommended to be used as an application condition.

Electrical/Optical Characteristics at $T_A = 25^{\circ}C$

Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Red (HDSP-521E, HDSP-523E)		1	1	I	1	
Luminous Intensity/Segment (Average per Segment) ^{a, b, c}	IV	5.13	7.30	_	mcd	I _F = 10 mA
Forward Voltage/Segment or DP ^d	V _F	—	1.95	2.50	V	I _F = 20 mA
Peak Wavelength	λ _P	—	633	—	nm	
Dominant Wavelength ^e	λ _d	—	622	—	nm	
Reverse Voltage/Segment or DP ^f	V _R	5	—	—	V	I _R = 100 μA
Green (HDSP-521G, HDSP-523G)		1	1	1	1	
Luminous Intensity/Segment (Average per Segment) ^{a, b, c}	IV	3.42	7.20	_	mcd	I _F = 10 mA
Forward Voltage/Segment or DP ^d	V _F	—	2.10	2.50	V	I _F = 20 mA
Peak Wavelength	λ _P	—	572	—	nm	
Dominant Wavelength ^e	λ _d	—	570	_	nm	
Reverse Voltage/Segment or DP ^f	V _R	5	—		V	I _R = 100 μA

HDSP-52xE Series, HDSP-52xG Series, HDSP-52xY Series Data Sheet

Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Yellow (HDSP-521Y, HDSP-523Y)		I			I	
Luminous Intensity/Segment (Average per Segment) ^{a, b, c}	IV	2.28	2.70	_		I _F = 10 mA
Forward Voltage/Segment or DP ^d	V _F	—	2.10	2.50	V	I _F = 20 mA
Peak Wavelength	λ _P	—	592	—	nm	
Dominant Wavelength ^e	λ_d	—	588	—	nm	
Reverse Voltage/Segment or DP ^f	V _R	5	—	—	V	I _R = 100 μA

a. The luminous intensity, $\mathbf{I}_V,$ is measured at the mechanical axis of the package.

b. The optical axis is closely aligned with the mechanical axis of the package.

- c. Tolerance is ±15%.
- d. Forward voltage tolerance is ± 0.1 V.
- e. The dominant wavelength, λ_d , is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.
- f. Indicates product final test condition. Long term reverse bias is not recommended.

Intensity Bin Limits (mcd at 10 mA)

Red

IV Bin Category	Min.	Max.
I	5.13	7.69
J	7.69	11.54
K	11.54	17.31

Color Categories	(Dominant
Wavelength)	

Tolerance for each bin limit is ±1 nm.

		Dominant Wavelength (nm)		
Color	Bin	Min.	Max.	
Green	3	570.50	573.10	
	2	573.50	576.50	
Yellow	2	587.00	584.50	
	3	584.50	587.00	

Tolerance for each bin limit is $\pm 15\%$.

Green

IV Bin Category	Min.	Max.
Н	3.42	5.13
I	5.13	7.69
J	7.69	11.54

Tolerance for each bin limit is $\pm 15\%$.

Yellow

IV Bin Category	Min.	Max.
G	2.28	3.42
Н	3.42	5.13
I	5.13	7.69

Tolerance for each bin limit is $\pm 15\%$.

Red

Figure 1: Relative Intensity vs. Wavelength

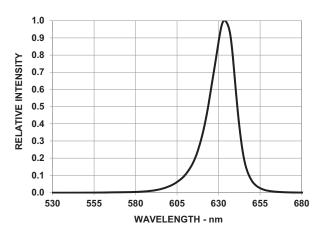


Figure 2: Forward Current vs. Forward Voltage

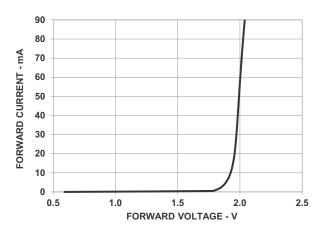


Figure 3: Relative Luminous Intensity vs. Forward Current

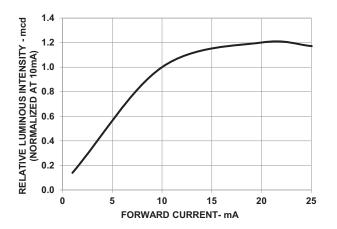
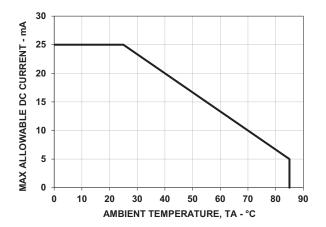


Figure 4: Maximum Forward Current vs. Ambient Temperature



Green

Figure 5: Relative Intensity vs. Wavelength

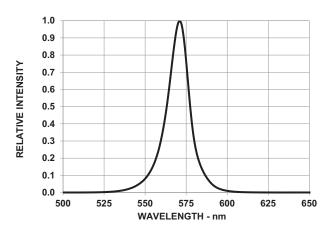


Figure 6: Forward Current vs. Forward Voltage

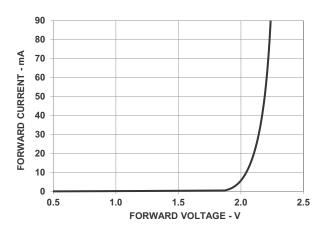


Figure 7: Relative Luminous Intensity vs. Forward Current

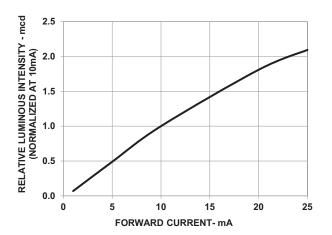
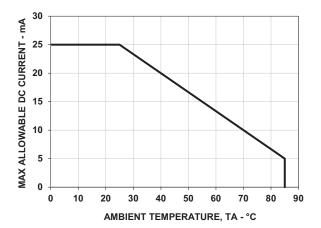


Figure 8: Maximum Forward Current vs. Ambient Temperature



Yellow

Figure 9: Relative Intensity vs. Wavelength

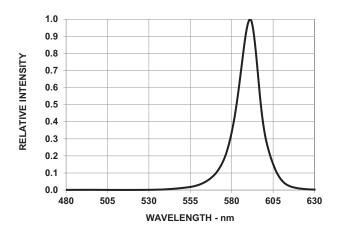


Figure 11: Relative Luminous Intensity vs. Forward Current

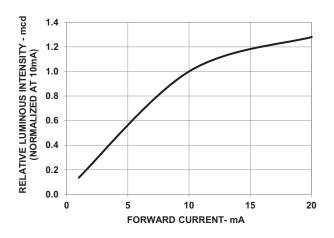


Figure 10: Forward Current vs. Forward Voltage 60 50

40

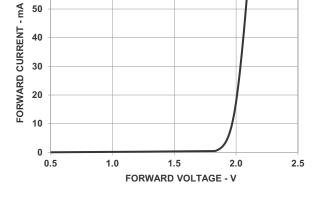
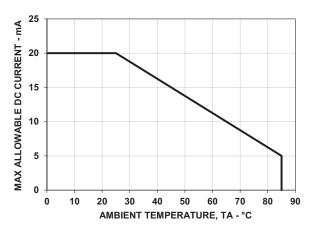


Figure 12: Maximum Forward Current vs. Ambient Temperature



Precautionary Notes

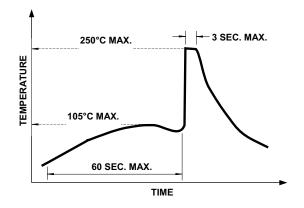
Soldering and Handling Precautions

- Set and maintain the wave soldering parameters according to the recommended temperature and dwell time. Perform daily checks on the profile to ensure that it conforms to the recommended conditions. Exceeding these conditions will over-stress the LEDs and cause premature failures.
- Use only bottom preheaters to reduce thermal stress experienced by the LEDs.
- Recalibrate the soldering profile before loading a new type of PCB. A PCB with different size and design (component density) will have different heat capacity and might cause a change in temperature experienced by the PCB if the same wave soldering setting is used.
- Do not perform wave soldering more than once.
- Any alignment fixture used during wave soldering must be loosely fitted and must not apply stress on the LEDs. Use non-metal material as it absorbs less heat during the wave soldering process.
- At elevated temperatures, the LEDs are more susceptible to mechanical stress. Allow the PCB to be sufficiently cooled to room temperature before handling. Do not apply stress to the LED when it is hot.
- Use wave soldering to solder the LED. Use hand soldering only for rework or touch up if unavoidable, but it must be strictly controlled to following conditions:
 - Soldering iron tip temperature = 315°C maximum
 - Soldering duration = 2 seconds maximum
 - Number of cycles = 1 only
 - Power of soldering iron = 50W maximum
- For ESD sensitive devices, apply proper ESD precautions at the soldering station. Use only an ESD-safe soldering iron.
- Do not touch the LED package body with the soldering iron except for the soldering terminals as it may cause damage to the LED.
- Confirm beforehand whether the functionality and performance of the LED are affected by soldering with hand soldering.
- Keep the heat source at least 1.6 mm away from the LED body during soldering.
- Design an appropriate hole size to avoid problems during insertion.
- Do not use cleaning agents from the ketone family (acetone, methyl ethylketone, and so on) and from the chlorinated hydrocarbon family (methylene chloride,

trichloroethylene, carbon tetrachloride, and so on) to clean the LED displays. All of these solvents attack or dissolve the encapsulating epoxies used to form the package of plastic LED parts.

- For the purposes of cleaning, wash with DI water only. Perform the cleaning process at room temperature only. Clear any water or moisture from the LED display immediately after washing.
- Use No clean solder paste for soldering.

Figure 13: Recommended Wave Soldering Profile



NOTE: The measurements are performed with a thermocouple mounted at the bottom of the PCB.

Application Precautions

- The drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the data sheet. Use constant current driving to ensure consistent performance.
- The circuit design must cater to the entire range of forward voltage (V_F) of the LEDs to ensure the intended drive current can always be achieved.
- The LED exhibits slightly different characteristics at different drive currents, which may result in a larger variation of performance (such as intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, ensure that the reverse bias voltage does not exceed the allowable limit of the LED.

- Avoid rapid change in ambient temperature, especially in high-humidity environments, because they cause condensation on the LED.
- If the LED is intended to be used in harsh or outdoor environment, protect the LED against damages caused by rain, water, dust, oil, corrosive gases, external mechanical stresses, and so on.

Eye Safety Precautions

LEDs may pose optical hazards when in operation. Do not look directly at operating LEDs because it might be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipment.

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